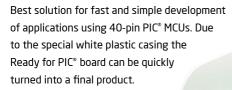
Ready^m for PIC[®]





DIP40



TO OUR VALUED CUSTOMERS

I want to express my thanks to you for being interested in our products and for having confidence in MikroElektronika.

The primary aim of our company is to design and produce high quality electronic products and to constantly improve the performance thereof in order to better suit your needs.

Nebojsa Matic General Manager

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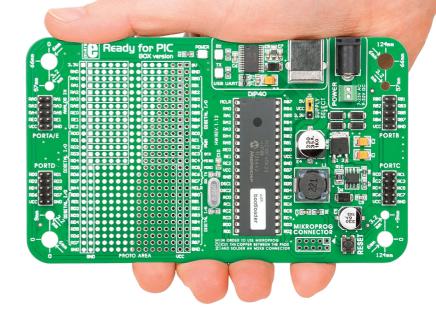
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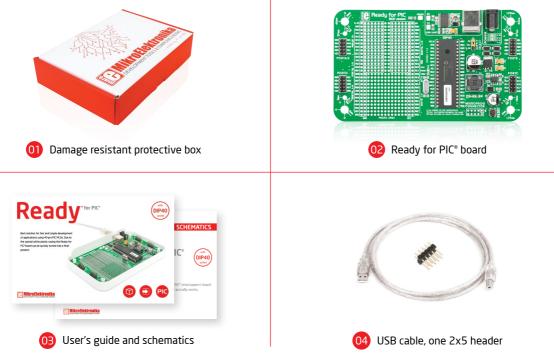
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Introduction

Ready for PIC® Board is the best solution for fast and simple development of various microcontroller applications. The board is equipped with the PIC18F45K22 MCU that is placed in a DIP 40 socket and contains male headers and connection pads for all available microcontroller ports. The pins are grouped according to their functions, which is clearly indicated on the silkscreen. The MCU comes preprogrammed with mikroBootloader, but it can also be programmed with mikroProg[™] programmer. The board also contains USB-UART module. prototyping area and a power supply circuit. It is specially designed to fit into the special white plastic casing so that you can turn your PIC[®] project into a final product.



Package contains



Key features

System specification



power supply

Via AC/DC connector 7-23V AC or 9-32V DC



power consumption

6.2mA in idle state (when on-board modules are off)



board dimensions

weight

~60g (0.13 lbs)

141 x 84mm (5.55 x 3.3 inch)



Power LED indicator UART communication LEDs (RX.TX) USB UART connector Power supply select Power adapter connector Power screw terminals Male headers Reset button mikroProg[™] connector PIC18F45K22 microcontroller Crystal oscillator Connection pads

14

01

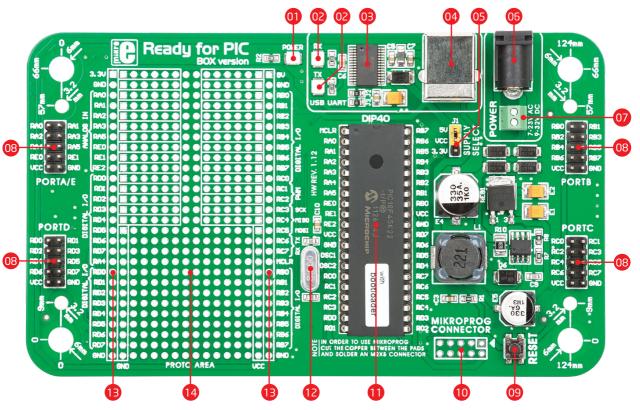
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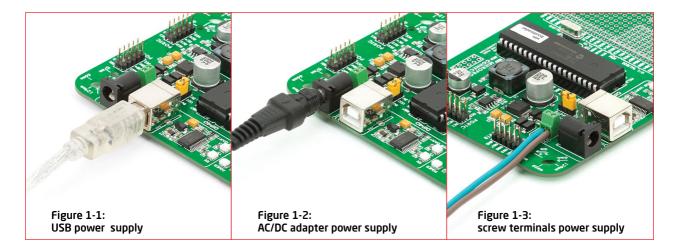
04 05

FTDI chip

Prototyping area



1. Power supply



Ready for PIC* board can be powered in three different ways: via USB connector (CN1), via adapter connector using external adapters (CN2) or via additional screw terminals (CN46). The USB connection can provide up to 500mA of current which is more than enough for the operation of every on-board module and the microcontroller as well. If you decide to use external power supply, voltage values must be within 7-23V AC or 9-32V DC range. Power LED ON (GREEN) indicates the presence of a power supply. Use only one of the suggested methods for powering the board. If you use an MCU with a 5V power supply place jumper J1 in the 5V position. Otherwise, it should be placed in the 3.3V position.

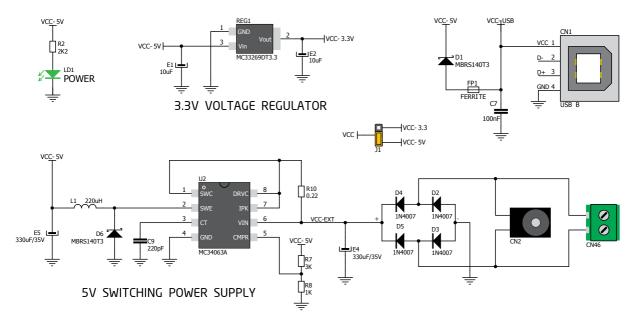


Figure 1-4: Power supply schematic

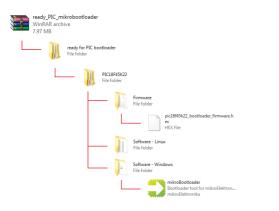
2. Programming with mikroBootloader

You can program the microcontroller with the bootloader that is preprogrammed into the device by default. To transfer .hex file from a PC to the MCU you need the bootloader software (mikroBootloader) which can be downloaded from:



http://www.mikroe.com/eng/downloads/get/1808/ ready_pic_mikrobootloader.zip

After the software is downloaded unzip it to the desired location and start **mikroBootloader** software.



mikroBootloader software

note	Before starting mikroBootloader, connect Ready for PIC® to a
	PC using the USB cable provided with the package

mikroElektronika Bootloader v2.1.0.0	Select MCU PIC18
1 Setup COM Port: COM1 port Baud Rate: 9600	Change refreshings Conn Rx Tx Settings Of Other Conn Rx Tx
2 Connect to MCU Connect	History Window
3 Choose Browse for HEX	
4 Start Begin uploading	
Bootloading progress bar	Show Activity
: No files opened.	

Figure 2-1: mikroBootloader window



When you start mikroBootloader, a window as shown in **Figure 2-1** should appear.

Identifying device COM port

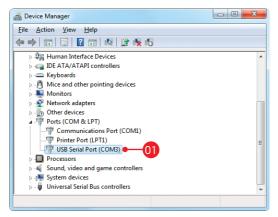
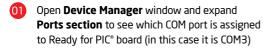


Figure 2-2: Identifying COM port



step 1 - Choosing COM port



Figure 2-3: Choosing COM port



- Click the Change Settings button
- From the drop down list, select appropriate COM port (in this case it is COM3)
- 3 Click **OK**

step 2 - Establishing connection

mikroElektronika Bo	otloader v2.1.0.0					X
mikroBo	otioade	Select MCU		PICI	18	•
1 Setup COM P port Baud R	ort: COM3 tate: 115200	Change Settings	Signals	Conn	Rx @	Tx O
2 Connect to MCU	Connect 🛑	SOT Port COM3		_		*
3 Choose HEX file	Browse for HEX					
4 Start bootloader	Begin uploading					Ŧ
Bootloading progress bar				s	how A	tivity
: No files opened.						

Figure 2-4: Connecting with mikroBootloader

Press the **Reset** button on the Ready for PIC[®] board and click the **Connect** button within 5s, otherwise the existing microcontroller program will run. If connected, the button's caption will be changed to **Disconnect**

step 3 - Browsing for .HEX file



Figure 2-5: Browse for HEX

Click the **Browse for HEX** button and from a pop-up window (**Figure 2-6**) choose a .HEX file to be uploaded to MCU memory

step 4 - Selecting .HEX file

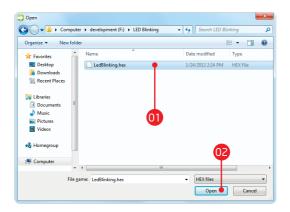
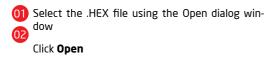


Figure 2-6: Locating and selecting .hex file



step 5 - Uploading .HEX file

mikroElektronika Bootloader v2.1.0.0	
mikroBootloader	Select MCU PIC18
1 Setup COM Port: COM3 Baud Rate: 115200	Change Conn Rx Tx Settings O
2 Connect Disconnect	History Window Setup: Port COM3. Waiting MCU response
3 Choose Browse for HEX	Connected. Opened: F:\LED Blinking\LedBlinking.hex
4 Start Begin uploading	
Bootloading progress bar	Show Activity
: F:\LED Blinking\LedBlinking.hex	

Figure 2-7: Begin uploading



To start .HEX file bootloading click the **Begin uploading** button

step 6 - Progress bar

mikroElektronika Bootloader v2.1.0.0				
mikroBootloader	Select MCU PIC18			
1 Setup COM Port: COM3 port Baud Rate: 115200	Change Settings			
	History Window Setup: Port COM3. Waiting MCU response			
Choose Browse	Connected. Opened: F:\LED Blinking\LedBlinking.hex Uploading			
4 Start Stop uploading	•			
Bootloading progress bar	Show Activity			
: F:\LED Blinking\LedBlinking.hex				

Figure 2-8: Progress bar



01 You can monitor .HEX file uploading via progress bar

step 7 - Finishing upload



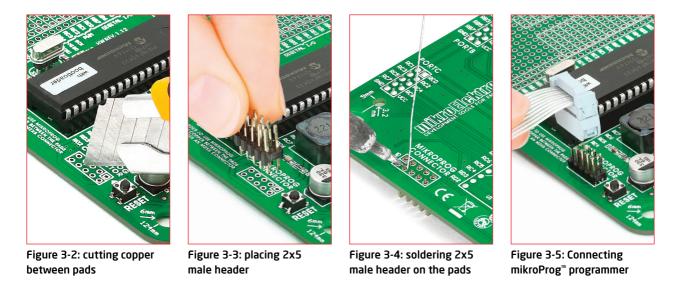
Figure 2-9: Restarting MCU

- - Click **OK** after the uploading process is finished
- 02 Press the **Reset** button on the Ready for PIC[®] board and wait for 5 seconds. Your program will run automatically

3. Programming with mikroProg^m programmer

The board is equipped with **mikroProg[™] connector pads**, which allow you to program the microcontroller using external mikroProg[™] programmer. Before attaching the programming connector, it is necessary to make a few adjustments (**Page 16**).

> Figure 3-1: mikroProg[™] programmer



First you need to cut the copper between pads for the external programmer, **Figure 3-2**. By doing so pins RB6, RB7, MCLR and VCC on the MCU will be separated from the rest of the board. After that it is time to place (**Figure 3-3**) and solder (**Figure 3-4**) a 2x5 male header on the pad **(CN5)**. Now attach the external mikroProg^m programmer connector on the 2x5 header, **Figure 3-5**. After the programming process is finished you can remove the programmer connector and solder jumpers over pads in order to enable pins RB6, RB7 to be used as I/O pins and MCLR to be used as a reset pin.

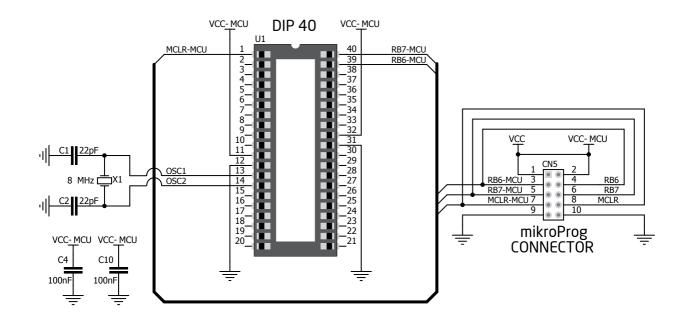


Figure 3-6: mikroProg[™] programmer connection schematic

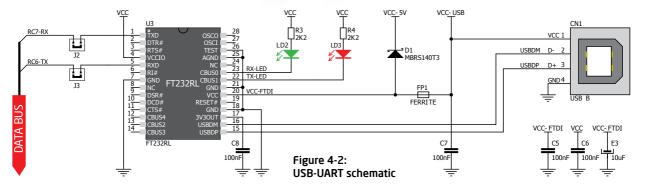
4. USB-UART

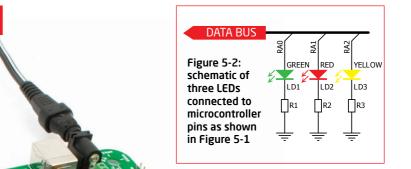
Fast on-board **FTDI*** **chip** allows Ready for PIC* to communicate with a PC or other UART devices using a USB-UART connection. USB-B connector (**CN1**) is used for connecting the USB cable. RX (receive) and TX (transmit) LEDs will indicate communication status. Before connecting the board to a PC, make sure that you have the appropriate **FTDI drivers** installed on your operating system. Drivers can be found at the following URL:

Figure 4-1: connected USB-UART



http://www.ftdichip.com/Drivers/VCP.htm



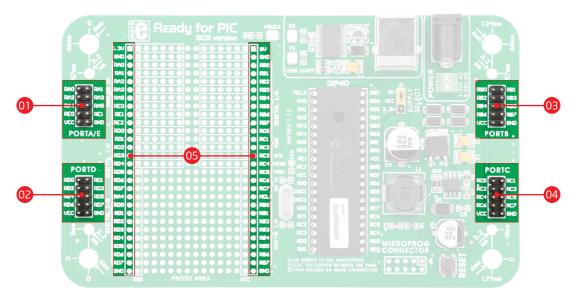


Proto area

allows you to expand your Ready for PIC* board with additional functionality. It can be done by placing your additional components on the available prototyping area. Pads are arranged in standard 100mils distance form factor. There are 30 groups of 6 connected pads, two groups of 13 connected power pads (GND and VCC) and 186 unconnected pads.

5. Prototyping area

6. Pin headers and connection pads



Each microcontroller pin is available for further connections through four on-board 2x5 connection headers and two 1x28 connection pads. Pins are grouped in four PORT groups (2x5 male headers) as well as per their functions (1x28 connection pads), which makes development and connections much easier. Everything is printed on the silkscreen, so that there will be no need of using microcontroller data sheet while developing. Before using the pins, it is necessary to solder **2x5 male headers** (1-4) on the board pads.

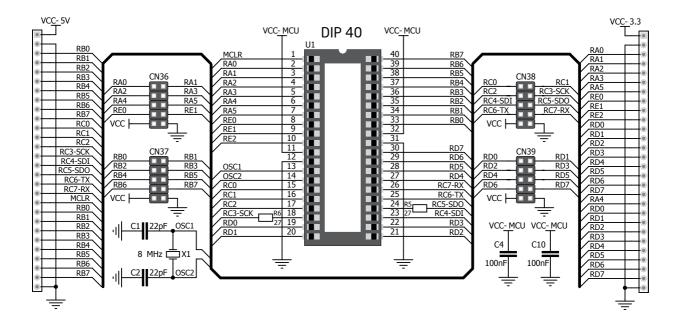
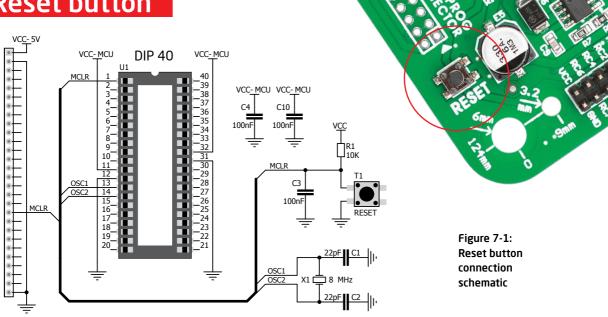


Figure 6-1: Schematic of pin headers and connection pads

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7. Reset button



Ready for PIC* board has a specialized reset circuit with a high-quality reset button which can be used to reset the program execution of the microcontroller. If you want to reset the circuit, press the on-board RESET button. It will generate a low voltage level on the microcontroller reset pin (input). In addition, a reset can be externally generated through MCLR pin on 1x28 connection pads.

8. Integrating with the casing



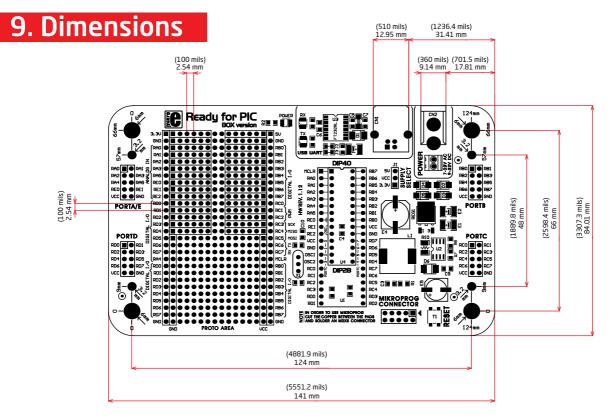
Figure 8-1: Place the board into the bottom part of the casing. Make sure that the connectors are aligned with square openings

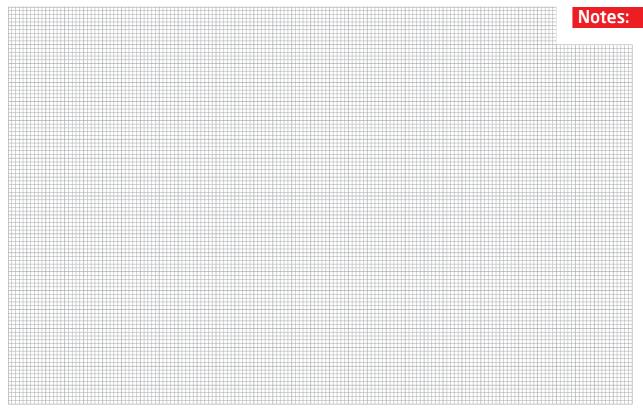
Figure 8-2: Wind screws into inner screw holes to fix the board with the bottom plastic casing



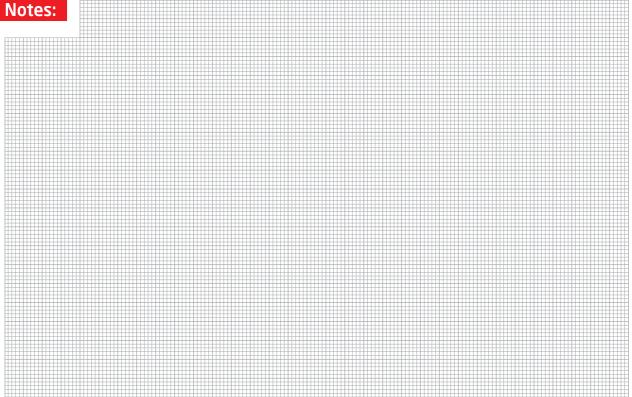
Figure 8-3: Place cover casing plastic and wind screws into outer screw holes to fix it with bottom plastics casing

Ready for PIC[®] can easily be integrated into the specialized white plastic casing. This feature is very convenient for turning the board into a final product. The white plastic casing contains inner and outer screw holes. Inner are used for fixing the board to the casing and outer are used for fixing the top part of the casing. Casing comes with holes for USB and power adapter connector, but you can customize it by drilling and cutting holes in specific areas, depending on the target application.









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